Documents Comprising the Bid: Technical & Financial Proposal

The Technical Envelope/Proposal shall contain the following:		
		Duly Signed Technical Proposal Submission Form (TPF 1); The bid security shall be limited to a Bid Securing Declaration or any of the following forms and amounts:
		> The amount of not less than PhP5,000,000.00, if bid security is in cash, cashier's/manager's check, bank draft/guarantee or irrevocable letter of credit; or
		> The amount of not less than PhP12,500,000.00, if bid security is in Surety Bond.
		Consultant's References (TPF 2);
		Comments & Suggestions of Consultant on the Terms of Reference & on
		Data, Services, & Facilities to be provided by the DOT (TPF 3);
		Description of the Methodology & Work Plan for Performing the Project (TPF 4);
		Team Composition & Task Projects (TPF 5);
		Format of Curriculum Vitae (CV) for Proposed Professional Staff (TPF 6);
		Time Schedule for Professional Personnel (TPF 7);
		Activity (Work) Schedule (TPF 8);
		Organizational Chart for the project; and Duly Notarized Omnibus Sworn Statement
		July Hotalized Chimisus Short Statement
Γŀ	e F	inancial Envelope/Proposal shall contain the following:
		Duly Signed Financial Proposal Submission Form (FPF 1); Summary of Costs (FPF 2); Breakdown of Price per Activity (FPF 3);

Note: All documents shall be current and updated and any missing document in the above mentioned checklist is a ground for outright rejection of the bid. Bidders are required to submit one (1) original and six (6) photocopies of their bids.

☐ Breakdown of Remuneration per Activity (FPF 4);

☐ Reimbursables per Activity (FPF 5); and

☐ Miscellaneous Expenses (FPF 6)

To facilitate the evaluation of the bids, bidders are advised to follow the arrangement in the above-mentioned checklist when placed in an Envelope, with documents tabbed, bounded and labeled accordingly.